

IMBM-H81B

Thermal Image Analysis Report

Summary	<input type="checkbox"/> Pass <input type="checkbox"/> Fail <input checked="" type="checkbox"/> Pass with Deviation Comment: <u>There are two temperature points marginal passed, the functions are stable.</u>			
	Test Result Summary			
	Critical	Major	Minor	Enhancement
Defect Found	0	0	0	2
Defect Unsolved	0	0	0	2

Issue date	QE Manager	Test Engineer
2016 / 06 / 02	KJ Wang	Ben Sun

Sample Configuration & Quantity Under Test

- **Model name : IMBM-H81B A1.01**
- **CPU : i7-4770k 3.9GHz**
- **Memory : Transcend DDR3L-1600 8GB*2**
- **2.5" SATA HDD : Seagate / 160GB ST9160412AS**
- **BIOS : IMBM-H81B R0.6 (MH81BM06)**
- **Test Software : Windows 8.1 / Run PassMark Burn In Test 8.0 Pro**
- **Power : ATX Power**
- **Heat Sink & Fan :**



Thermal Image Analysis

1. Test Date: 2015-05-27

2. Test Product: IMBM-H81B A1.01

3. Test Site: AAEON QE Dept.

4. Temperature Measurement:

4.1. 40 Channel Thermal Recorder:

4.1.1 YOKOGAWA Inc,

4.2.2 Model: DA100-13-1D

Date of Calibration: 2015/09/10

Serial Number: 12A323190

4.2. IR Scanner: Infrared Camera

4.2.1 NEC Avio Infrared Technologies Co., Ltd.

4.2.2 Model: Thermo GEAR G100W2-D

Date of Calibration: 2015/12/01

Serial Number: 1051444

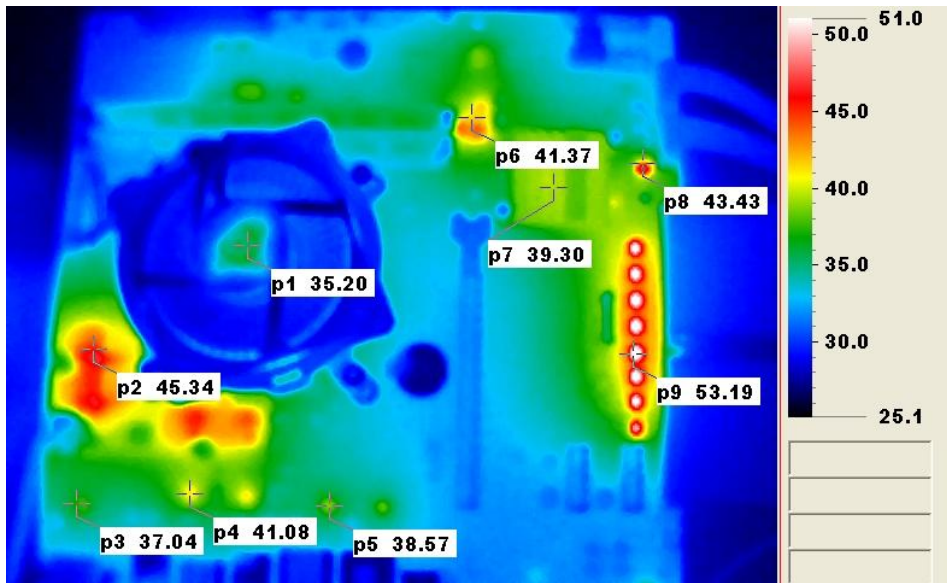
5. Test Condition:

Test by DA-100: 26.2°C with Heat Sink & Fan

6. Take Picture Time:

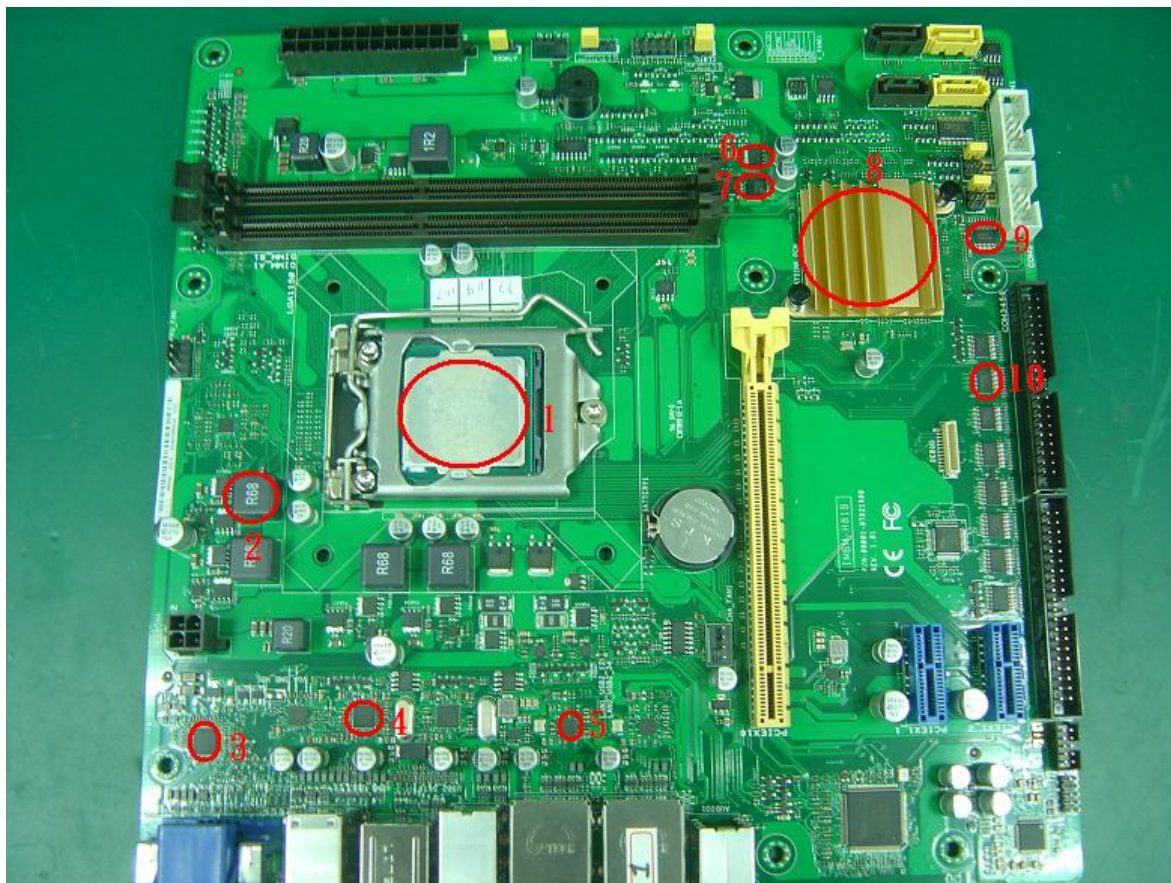
After power on 2 hours

Temperature Profile Test: Component Side:



Terminal Recorder:

Measuring Thermal Couple Position :



Using YOKOGAWA / DARWIN DA100-100-13-1D test

Point	Position	Describe	Tc (*1) (°C)	TAT(*2)		TPT(*3)	Note
				26.0°C	50°C		
1	CPU	intel i7-4770k Processor 3.9GHz	72.72	52.6	76.6	NOTE4	
2	PI4	INDUCTOR 0.68UH/35A 1.5φ DIP/ CHUNG SHUO/CS1112-R68-I43U	125	44.5	68.5		
3	Gu402	C.S ASM1442K (A1) QFN-48/ ASMEDIA	85	41.4	65.4		
4	U14	C.S ASM1042A TQFN-48L/ ASMEDIA	85	44.7	68.7		
5	L1u1	C.S RTL8111G-CG QFN-32 / REALTEK	100	41.1	65.1		
6	Pq823	N-MOSFET PH6030DLVX SOT669 / N-MOSFET PH6030DLVX SOT669	150	43.9	67.9		
7	Pq825	N-MOSFET QM3052M6 PRPAK5X6 / UBIQ	150	44.5	68.5		
8	Su1	C.S LYNXPOINT-DT (C2) FCBGA708 / INTEL 929137/82H81/SR177	90	42.2	66.2		
9	BU11,	HF INTERFACE 75232G-P20-R / UTC TSSOP-20	85	49.4	73.4		
10	BU5	HF INTERFACE 75232G-P20-R / UTC TSSOP-20	85	54.2	78.2	NOTE4	
11		RAM	85	40.1	64.1		

Note(*):

- "Tc" indicates the component's case maximum temperature value specified in its datasheet.
 - "TAT" indicates the actual measured temperature under product specification.
 - "TPT" indicates the predicted temperature under 25°C working environmental.
 - Judgment Criteria:**
 - Fail** : $T_m > T_c + 5^\circ\text{C}$; The measured value is over specification plus margin.
 - Margin** : $T_c + 5^\circ\text{C} > T_m > T_c - 10^\circ\text{C}$; The measured value is within specification with margin.
For FANLESS system application, it is strongly recommended to add thermal dissipation design for better reliability.
 - Pass** : $T_m < T_c - 10^\circ\text{C}$; The measured value is with safety margin.
 - RTC battery avoid to put on heat position. Please do not exceed battery temperature specification.
4. Defect NO. [W160101E01](#)